IEC 62680-1-2

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INTERNATIONAL STANDARD

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Universal serial bus interfaces for data and power
Part 1-2: Common components – USB Power Delivery specification

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Interfaces de bus universel en série pour les données et l'alimentation électrique
Partie 1-2: Composants communs – Spécification de l'alimentation électrique par port USB

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UNIVERSAL SERIAL BUS INTERFACES FOR DATA AND POWER

Part 1-2: Common components – USB Power Delivery specification

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CDV	Report on voting
100/3189/CDV	100/3251/RVC

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This standard is the USB-IF publication Universal Serial Bus Power Delivery Specification Revision 3.0, Version 1.2.

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Revision: ***3.0***
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Release date: ***21 June 2018***

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Revision History

Revision	Version	Comments	Issue Date
1.0	1.0	Initial release Revision 1.0	5 July 2012
1.0	1.1	Including errata through 31-October-2012	31 October 2012
1.0	1.2	Including errata through 26-June-2013	26 June 2013
1.0	1.3	Including errata through 11-March-2014	11 March 2014
2.0	1.0	Initial release Revision 2.0	11 August 2014
2.0	1.1	Including errata through 7-May 2015	7 May 2015
2.0	1.2	Including errata through 25-March-2016	25 March 2016
2.0	1.3	Including errata through 11-January-2017	11 January 2017
3.0	1.0	Initial release Revision 3.0	11 December 2015
3.0	1.0a	Including errata through 25-March-2016	25 March 2016
3.0	1.1	Including errata through 12-January-2016	12 January 2017
3.0	1.2	Including errata through 21-June-2018:	21 June 2018

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